IGBT - Field Stop, Trench 1200 V, 40 A

FGH12040WD

Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 2nd generation IGBTs offer the optimum performance for welder applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: T_J =175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- Low Saturation Voltage: $V_{CE(sat)} = 2.3 V (Typ.) @ I_C = 40 A$
- 100% of the Parts Tested for I_{LM} (Note 1)
- Short Circuit Ruggedness > 5 us @ 150°C
- High Input Impedance
- This Device is Pb-Free and is RoHS Compliant

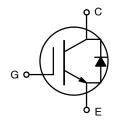
Applications

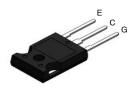
• Only for Welder



ON Semiconductor®

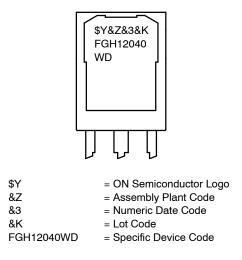
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TO-247 long leads CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		FGH75T65SHDTL4	Unit	
V _{CES}	Collector to Emitter Voltage		1200	V	
V _{GES}	Gate to Emitter Voltage		±25	V	
	Transient Gate to Emitter Voltage	±30	V		
Ι _C	Collector Current 7	Γ _C = 25°C	80	А	
	٦ ٦	Γ _C = 100°C	40	А	
I _{LM} (Note 1)	Clamped Inductive Load Current	Γ _C = 25°C	100	А	
I _{CM} (Note 2)	Pulsed Collector Current		100	А	
١ _F	Diode Continuous Forward Current	Γ _C = 25°C	80	А	
	Diode Continuous Forward Current	Γ _C = 100°C	40	А	
I _{FM} (Note 2)	Diode Maximum Forward Current		100	А	
SCWT(Note 3)	Short Circuit Withstand Time	Γ _C = 150°C	5	us	
PD	Maximum Power Dissipation	Γ _C = 25°C	428	W	
	٦ ٦	Γ _C = 100°C	214	W	
TJ	Operating Junction Temperature		–55 to +175	°C	
T _{STG}	Storage Temperature Range		–55 to +175	°C	
ΤL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality sheese exceeding index index in the Maximum Hating's table may damage the should not be assumed, damage may occur and reliability may be affected. 1. $V_{CC} = 600 \text{ V}$, $V_{GE} = 15 \text{ V}$, $I_C = 100 \text{ A}$, $R_G = 23 \Omega$, Inductive Load. 2. Repetitive rating: Pulse width limited by max. junction temperature. 3. $V_{CC} = 600 \text{ V}$, $V_{GE} = 12 \text{ V}$

THERMAL CHARACTERISTICS

Symbol	Parameter	FGH75T65SHDTL4	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	0.35	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	1.4	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH12040WD-F155	FGH12040WD	TO-247	Tube	Ι	_	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
OFF CHARACTERISTICS							
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 250 uA	1200	-	-	V	
$\Delta\text{BV}_{\text{CES}}/\Delta\text{T}_{\text{J}}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 V, I_C = 250 uA$	-	1.2	-	V/°C	
ICES	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	1	-	250	uA	
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
ON CHARACT	ERISTICS	•				-
V _{GE(th)}	G-E Threshold Voltage	I_{C} = 40 mA, V_{CE} = V_{GE}	4.8	6.4	8.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 40 \text{ A}, \text{ V}_{GE} = 15 \text{ V},$ $T_{C} = 25^{\circ}\text{C}$	_	2.3	2.9	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 175°C	-	2.7	_	V
YNAMIC CH	ARACTERISTICS				•	
Cies	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	2800	-	pF
C _{oes}	Output Capacitance		_	105	-	pF
C _{res}	Reverse Transfer Capacitance		-	60	-	pF
WITCHING C	HARACTERISTICS					
T _{d(on)}	Turn–On Delay Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \\ R_{G} = 23 \Omega, \text{ V}_{GE} = 15 \text{ V},$	_	45	_	ns
Tr	Rise Time	Inductive Load, $T_C = 25^{\circ}C$	_	70	-	ns
T _{d(off)}	Turn–Off Delay Time		-	560	-	ns
T _f	Fall Time		-	15	-	ns
Eon	Turn-On Switching Loss		-	4.1	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.0	-	mJ
E _{ts}	Total Switching Loss		-	5.1	-	mJ
T _{d(on)}	Turn–On Delay Time	V _{CC} = 600 V, I _C = 40 A, R _G = 23 Ω, V _{GE} = 15 V,	-	43	-	ns
Tr	Rise Time	Inductive Load, $T_C = 175^{\circ}C$	-	73	-	ns
T _{d(off)}	Turn-Off Delay Time		-	572	-	ns
T _f	Fall Time		-	58	-	ns
Eon	Turn-On Switching Loss		-	6.9	-	mJ
E _{off}	Turn-Off Switching Loss		_	1.9	-	mJ
E _{ts}	Total Switching Loss		_	8.8	-	mJ
Qg	Total Gate Charge	$V_{CE} = 600 \text{ V}, I_{C} = 40 \text{ A},$	-	226	_	nC
Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	18	-	nC
Q _{gc}	Gate to Collector Charge		-	155	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Co	Min	Тур	Max	Unit	
V_{FM}	Diode Forward Voltage	I _F = 40 A	$T_{C} = 25^{\circ}C$	-	3.6	4.7	V
			T _C = 175°C	-	2.9	-	
t _{rr}	Diode Reverse Recovery Time	$V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A}, dI_{F}/dt = 200 \text{ A/us}, T_{C} = 25^{\circ}\text{C}$		-	71	-	ns
۱ _{rr}	Diode Peak Reverse Recovery Current			-	6.8	-	А
Q _{rr}	Diode Reverse Recovery Charge			-	242	-	nC
E _{rec}	Reverse Recovery Energy	V _R = 600 V, I _F = 40 / T _C = 175°C	A, dI _F /dt = 200 A/μs,	-	690	-	uJ
t _{rr}	Diode Reverse Recovery Time	10-113-0		-	500	-	ns
I _{rr}	Diode Peak Reverse Recovery Current]		-	17	-	А
Q _{rr}	Diode Reverse Recovery Charge			_	4250	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

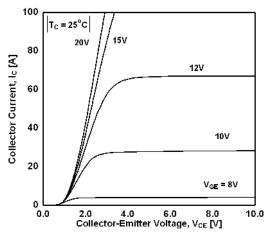


Figure 1. Typical Output Characteristics

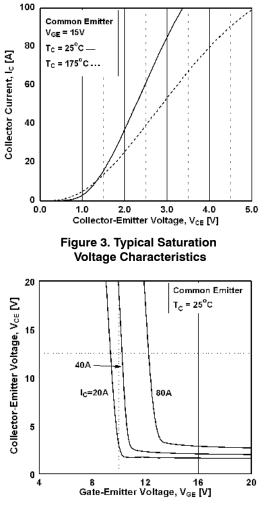


Figure 5. Saturation Voltage vs. V_{GE}

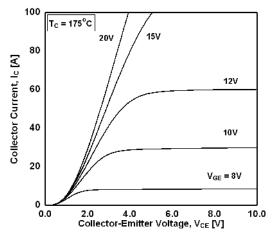
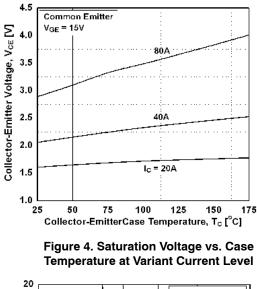


Figure 2. Typical Output Characteristics



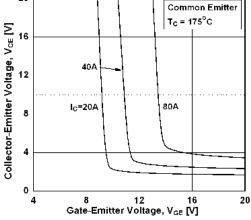


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

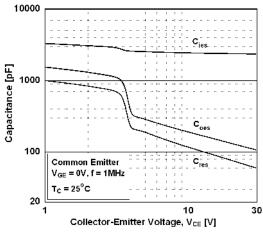


Figure 7. Capacitance Characteristics

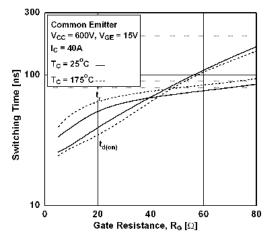


Figure 9. Turn-on Characteristics vs. **Gate Resistance**

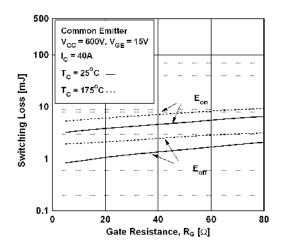
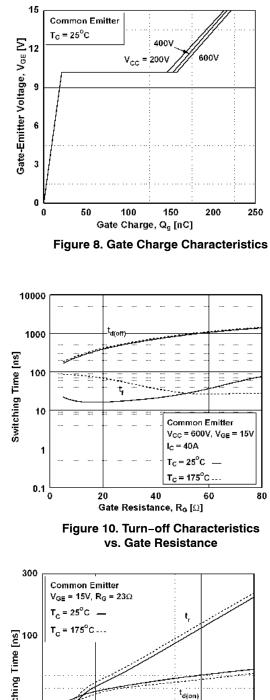


Figure 11. Switching Loss vs. Gate Resistance



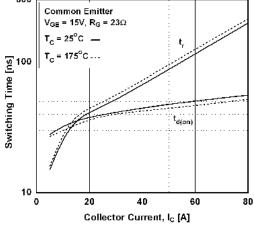
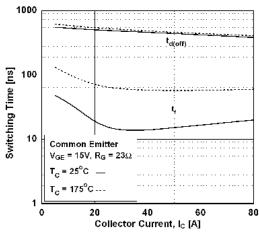
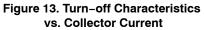


Figure 12. Turn-on Characteristics vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





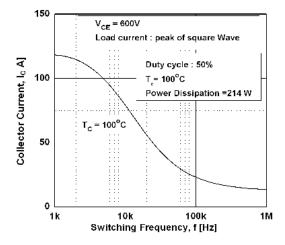
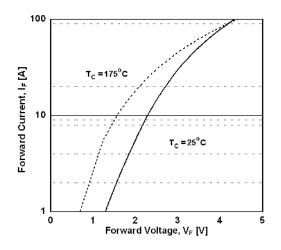


Figure 15. Load Current vs. Frequency





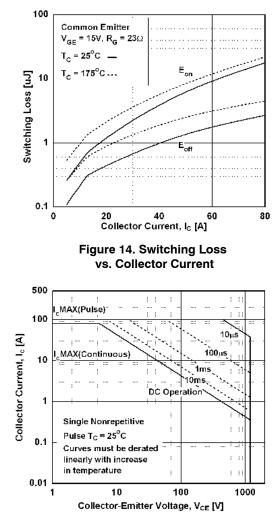


Figure 16. SOA Characteristics

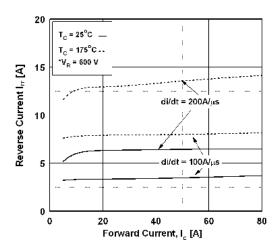


Figure 18. Reverse Recovery Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

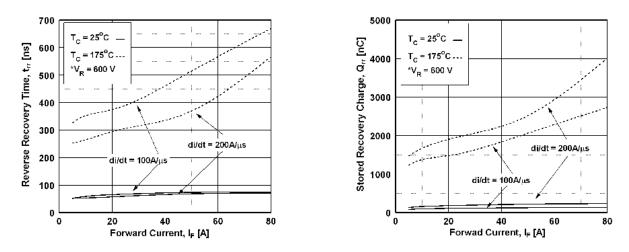
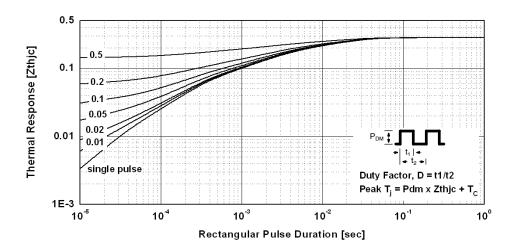
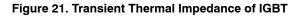


Figure 19. Reverse Recovery Time







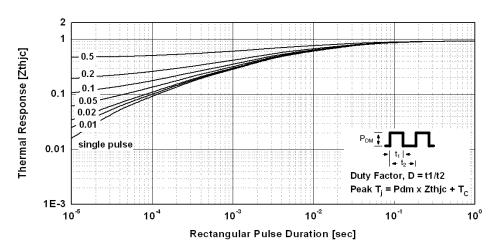
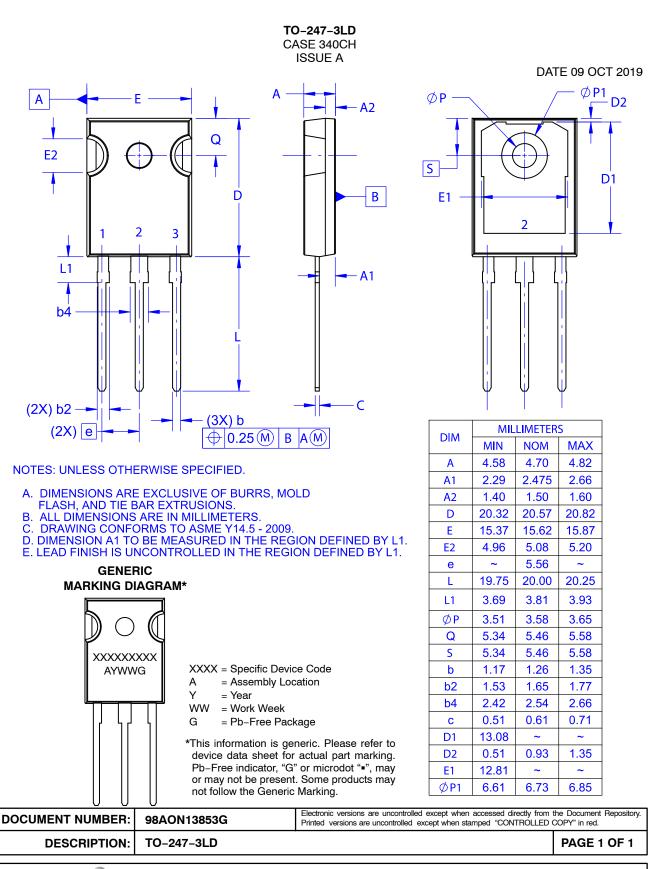


Figure 22. Transient Thermal Impedance of Diode





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